

High Power Infrared Emitting Diode, 850 nm, Surface Emitter Technology



DESCRIPTION

As part of the [SurfLight™](#) portfolio, the VSMY98545 is an infrared, 850 nm emitting diode based on surface emitter technology with high radiant power and high speed, molded in low thermal resistance SMD package with lens. A 42 mil chip provides outstanding low forward voltage and allows DC operation of the device up to 1 A.

FEATURES

- Package type: surface mount
- Package form: High power SMD with lens
- Dimensions (L x W x H in mm): 3.85 x 3.85 x 2.24
- Peak wavelength: $\lambda_p = 850$ nm
- High reliability
- High radiant power
- High radiant intensity
- Angle of half intensity: $\phi = \pm 45^\circ$
- Low forward voltage
- Designed for high drive currents: Up to 1 A (DC) and up to 5 A pulses
- Low thermal resistance: $R_{thJP} = 10$ K/W
- Floor life: 168 h, MSL 3, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Infrared illumination for CMOS cameras (CCTV)
- Illumination for cameras (3D gaming)
- Machine vision
- 3D TV

PRODUCT SUMMARY

| COMPONENT | I_e (mW/sr) | ϕ (deg) | λ_p (nm) | t_r (ns) |
|-----------|---------------|--------------|------------------|------------|
| VSMY98545 | 350 | ± 45 | 850 | 15 |

Note

- Test conditions see table “Basic Characteristics”

ORDERING INFORMATION

| ORDERING CODE | PACKAGING | REMARKS | PACKAGE FORM |
|---------------|---------------|----------------------------|----------------------|
| VSMY98545 | Tape and reel | MOQ: 600 pcs, 600 pcs/reel | High power with lens |

Note

- MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
|---------------------------------|---|------------|-------------|------------------|
| Reverse voltage | | V_R | 5 | V |
| Forward current | | I_F | 1 | A |
| Peak forward current | $t_p/T = 0.5$, $t_p = 100 \mu\text{s}$ | I_{FM} | 2 | A |
| Surge forward current | $t_p = 100 \mu\text{s}$ | I_{FSM} | 5 | A |
| Power dissipation | | P_V | 2.3 | W |
| Junction temperature | | T_j | 125 | $^\circ\text{C}$ |
| Operating temperature range | | T_{amb} | -40 to +95 | $^\circ\text{C}$ |
| Storage temperature range | | T_{stg} | -40 to +100 | $^\circ\text{C}$ |
| Soldering temperature | Acc. figure 10, J-STD-20 | T_{sd} | 260 | $^\circ\text{C}$ |
| Thermal resistance junction/pin | Acc. J-STD-051, soldered on PCB | R_{thJP} | 10 | K/W |

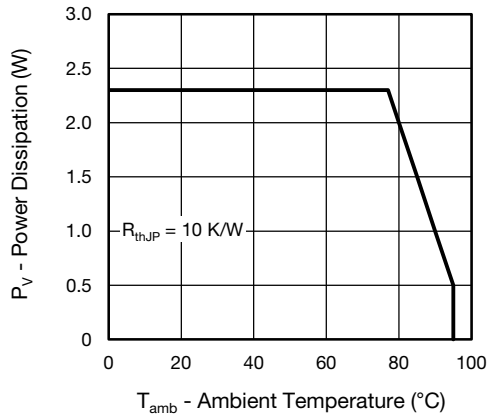


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

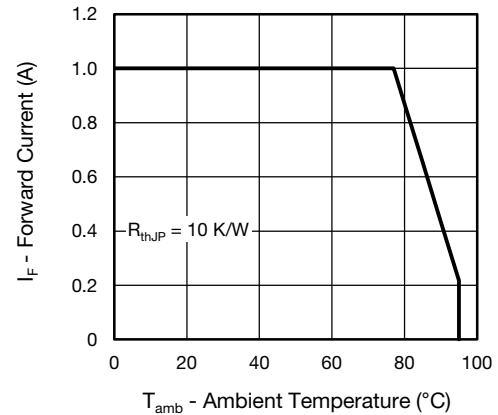


Fig. 2 - Forward Current Limit vs. Ambient Temperature

| BASIC CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) | | | | | | |
|---|---|------------------|------------------------------------|----------|------|---------------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Forward voltage | $I_F = 1\text{ A}$, $t_p = 20\text{ ms}$ | V_F | | 1.8 | 2.3 | V |
| | $I_F = 5\text{ A}$, $t_p = 100\text{ }\mu\text{s}$ | V_F | | 3.3 | | V |
| Temperature coefficient of V_F | $I_F = 1\text{ A}$ | TK_{V_F} | | -0.74 | | mV/K |
| Reverse current | $V_R = 5\text{ V}$ | I_R | not designed for reverse operation | | | μA |
| Radiant intensity | $I_F = 1\text{ A}$, $t_p = 20\text{ ms}$ | I_e | 230 | 350 | 550 | mW/sr |
| | $I_F = 5\text{ A}$, $t_p = 100\text{ }\mu\text{s}$ | I_e | | 1600 | | mW/sr |
| Radiant power | $I_F = 1\text{ A}$, $t_p = 20\text{ ms}$ | ϕ_e | | 660 | | mW |
| Temperature coefficient of ϕ_e | $I_F = 1\text{ A}$ | TK_{ϕ_e} | | -0.14 | | %/K |
| Angle of half intensity | | φ | | ± 45 | | deg |
| Peak wavelength | $I_F = 1\text{ A}$ | λ_p | | 850 | | nm |
| Spectral bandwidth | $I_F = 1\text{ A}$ | $\Delta\lambda$ | | 30 | | nm |
| Temperature coefficient of λ_p | $I_F = 1\text{ A}$ | TK_{λ_p} | | 0.2 | | nm/K |
| Rise time | $I_F = 1\text{ A}$ | t_r | | 15 | | ns |
| Fall time | $I_F = 1\text{ A}$ | t_f | | 18 | | ns |

BASIC CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

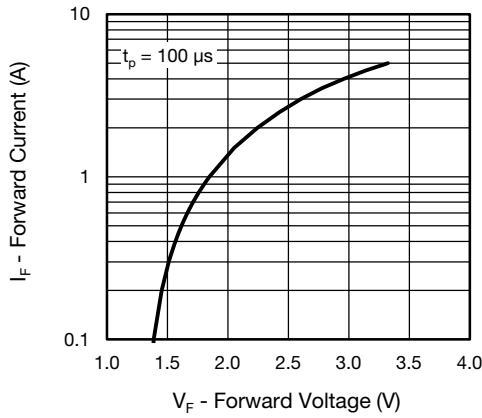


Fig. 3 - Forward Current vs. Forward Voltage

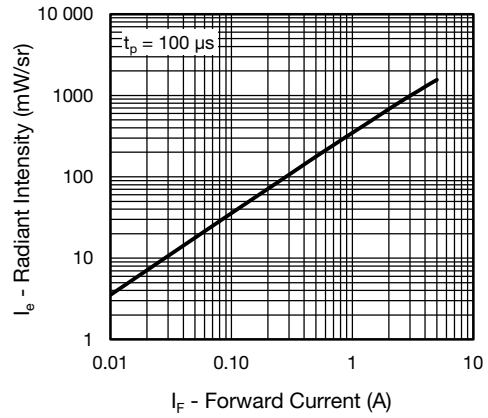


Fig. 6 - Radiant Intensity vs. Forward Current

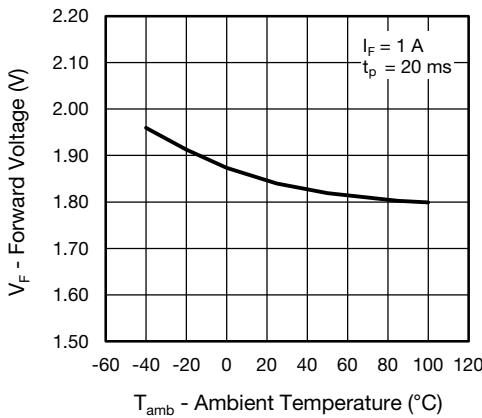


Fig. 4 - Forward Voltage vs. Ambient Temperature

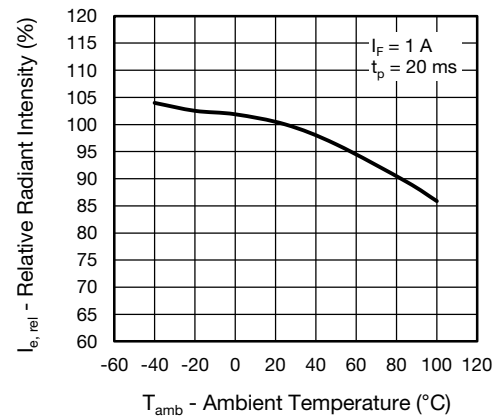


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

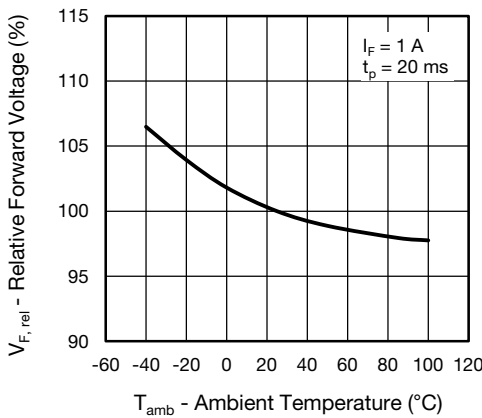


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

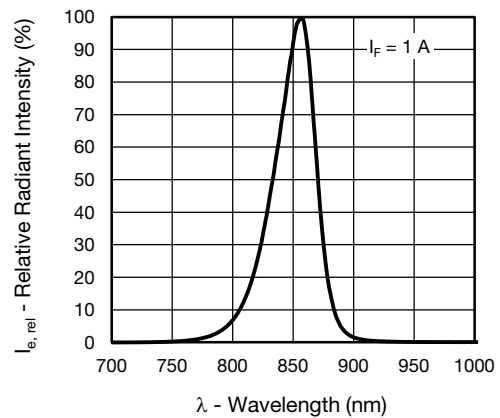


Fig. 8 - Relative Radiant Power vs. Wavelength

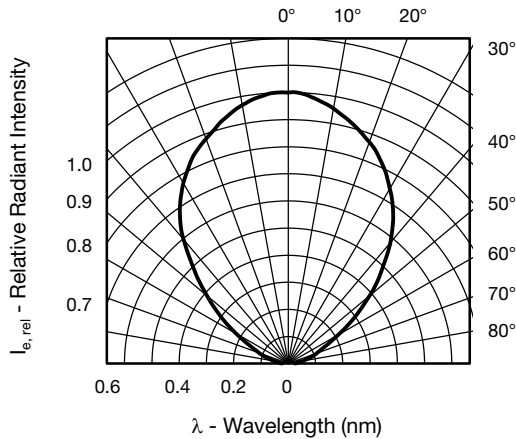
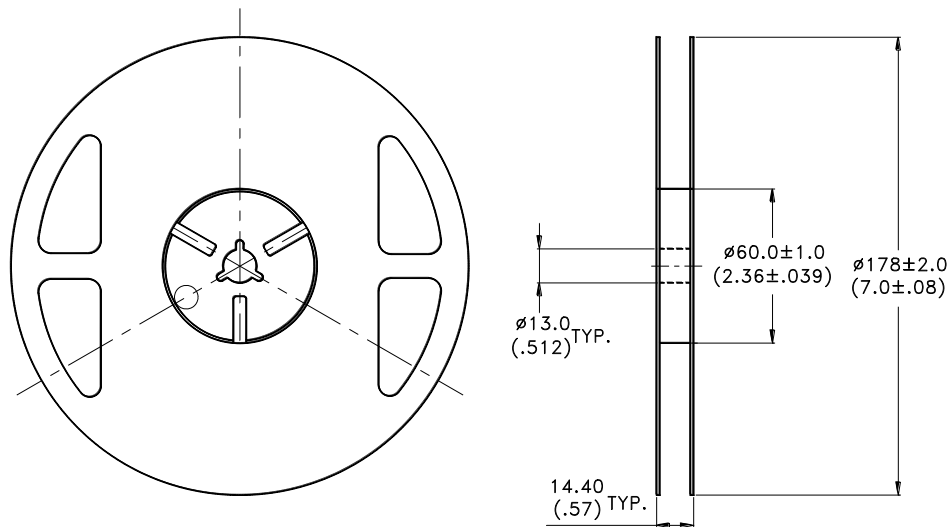


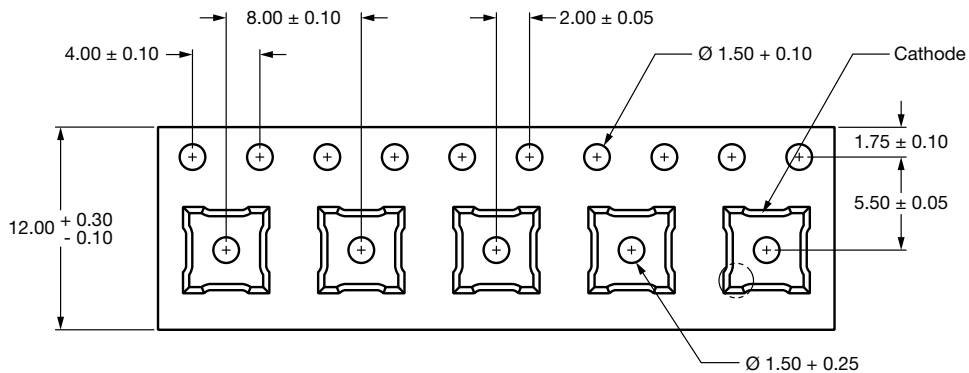
Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

TAPING DIMENSIONS in millimeters



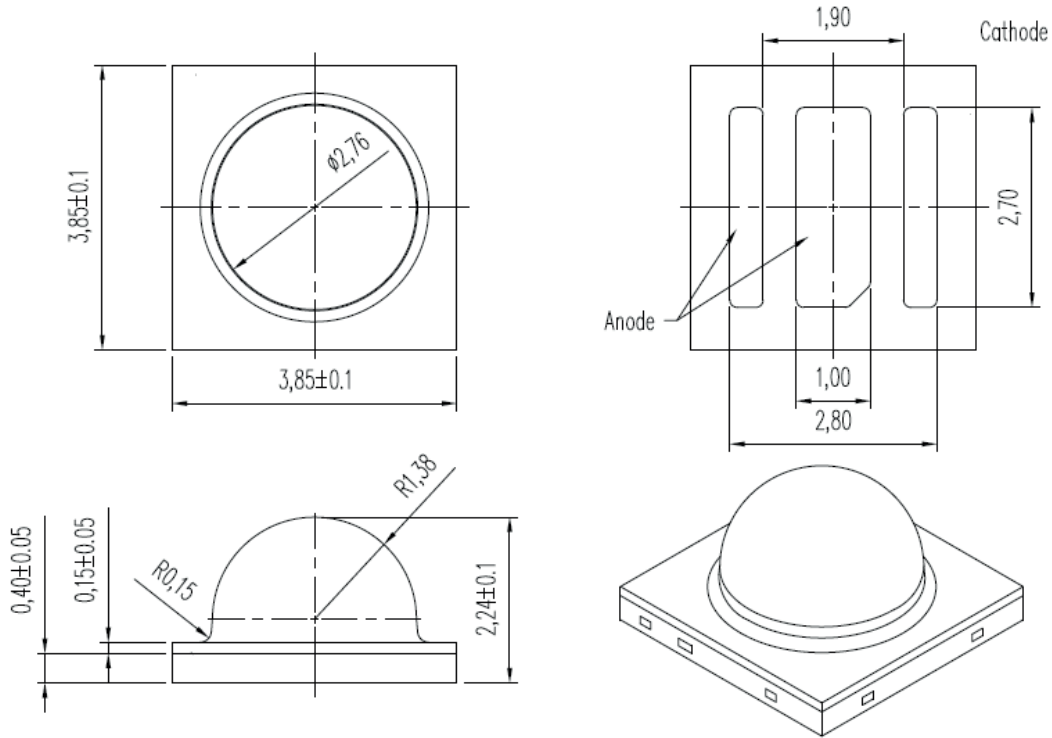
Notes

- Empty component pockets sealed with top cover tape.
- 7 inch reel - 600 pieces per reel.
- The maximum number of consecutive missing lamps is two.
- In accordance with ANSI/EIA 481-1-A-1994 specifications.



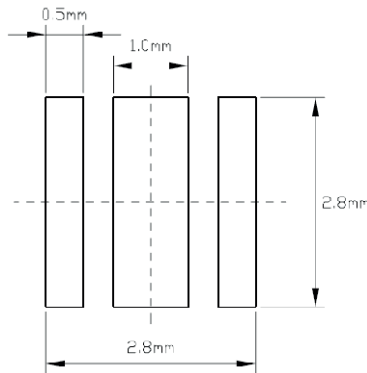


PACKAGE DIMENSIONS in millimeters



Notes

- Tolerance is ± 0.10 mm (0.004") unless otherwise noted.
- Specifications are subject to change without notice.



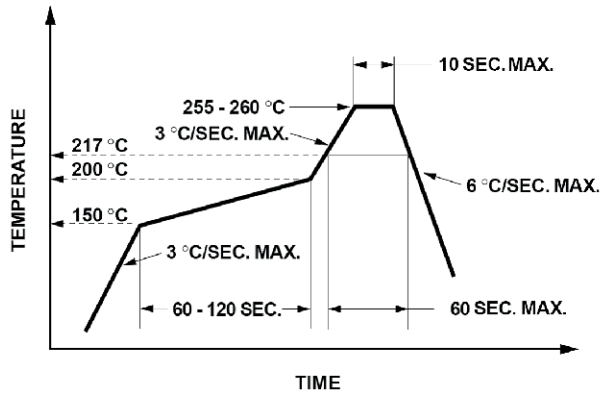
SOLDER PROFILE


Fig. 10 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: $T_{amb} < 30\text{ °C}$, $RH < 60\%$

Moisture sensitivity level 3, acc. to J-STD-020B

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), $RH < 5\%$.



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- Поставка более 17-ти миллионов наименований электронных компонентов;
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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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